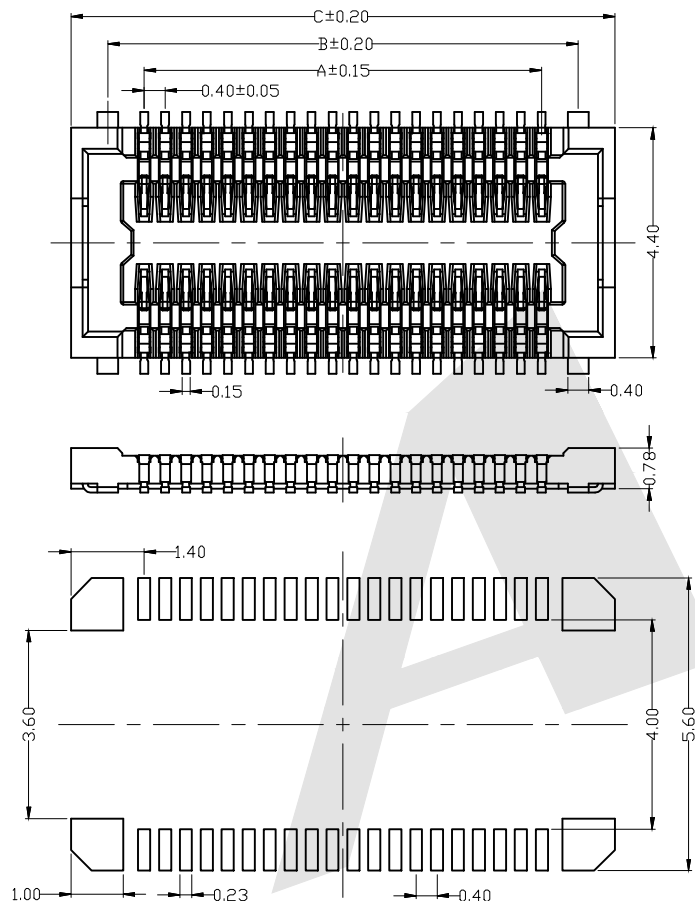
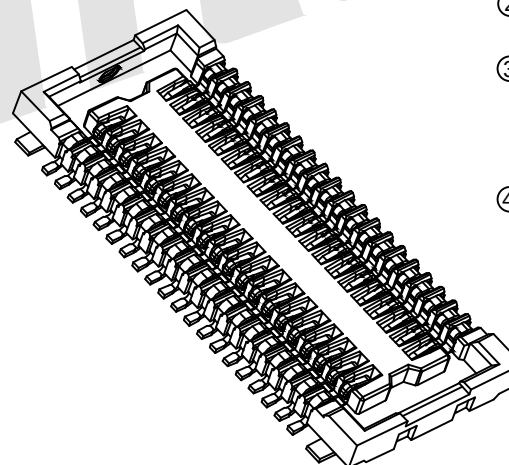


HSF  RoHS



RECOMMENDED PCB LAYOUT



SPECIFICATIONS:

Current Rating:0.5A
Voltage Rating:50V AC/DC
Withstanding voltage:150V AC Ong minute
Contact Resistance:50milliohm Max
Insulation Resistance:100Megohm Min
Operation Temperature:-20°C to +105°C

Insulator:LCP (UL94V-0) Black
Contact Material:Phosphor Btonze
Contact plating:Au or Sn over Ni

Ordering Code:

BB0.4 - F - 1.0 - X - X - X - 02
① ② ③ ④ ⑤ ⑥ ⑦

- ① Series NO:
0.4mm Board to Board connector
- ② M:Male F:Female
- ③ mating Height:
1.0=1.0mm
- ④ NO. of contacts:
see table
For example
10:10poles
- ⑤ Contact Plating
G0: Gold flash
G1: 3u" Gold
G2: 5u" Gold
G3: 10u" Gold
G4: 15u" Gold
G5: 30u" Gold
SN:Tin
- ⑥ Packing
T:Tube A:Tray
B:Bag U:Tube+CAP
R:tape&Reel
W:tape&Reel+CAP
- ⑦ serial number:
02

PIN NO.	10	24	30	34	40	50	60	70	80
A	1.60	4.40	5.60	6.40	7.60	9.60	11.60	13.60	15.60
B	3.00	5.80	7.00	7.80	9.00	11.00	13.00	15.00	17.00
C	4.40	7.20	8.40	9.20	10.40	12.40	14.40	16.40	18.40

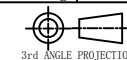
Unless Otherwise specified tolerance	
X. ± 0.35	X. XX: ± 0.20
X. X: ± 0.25	X. XXX: ± 0.15
SCALE: As Shown	UNIT: mm
DRAW Mo Guo Xuan	DATE 12/11/2018
CHECK BobYang	DATE 12/11/2018

 ANTENK ELECTRONICS CO., LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE: 0.4mm Board to Board connector,
Female,mating Height=1.0mm

DRAWING NO: BB0.4F-1.0XXX02

PRODUCT NO: BB0.4F-1.0XXX02



REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		